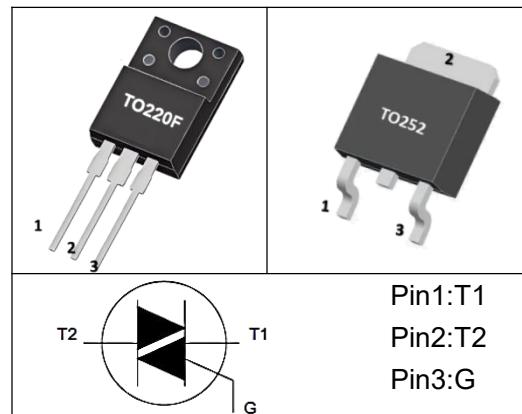




■ GENERAL DESCRIPTION

Glass passivated , sensitive gate triac in a plastic envelope, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.



■ MARKING



: HY LOGO

BT138=Device Code

800E:VDRM/VRRM=800V

XXXX=Date Code

Solid Dot=Green molding compound

■ ABSOLUTE MAXIMUM RATINGS (TC=25°C, unless otherwise specified)

SYMBOL	PARAMETER		TEST CONDITION	RATINGS	UNIT
V_{DRM}	Repetitive Peak Off-State Voltage	BT138-600	$T_j = 25^\circ\text{C}$	600	V
		BT138-800		800	
$I_{T(RMS)}$	RMS On-State Current(Full sine wave, $TMB \leq 99^\circ\text{C}$)			12	A
I_{TSM}	Non Repetitive Peak. On-State Current		$t=20\text{ms}$	95	A
			$t=16.7\text{ms}$	105	
$I^2 t$	$I^2 t$ For Fusing		$t=10\text{ms}$	45	$\text{A}^2 \text{s}$
dI/dt	Repetitive Rate of Rise of On-state Current after Triggering ($I_{TM}=20\text{A}$, $I_G=0.2\text{A}$, $dI/dt=0.2\text{A}/\mu\text{s}$)		$T2+$ G-	50	$\text{A}/\mu\text{s}$
			$T2+$ G-	50	
			$T2-$ G-	50	
			$T2-$ G+	10	
V_{GM}	Peak Gate Voltage			5	V
I_{GM}	Peak Gate Current			2	A
$P_{G(AV)}$	Average Gate Power			0.5	W
P_{GM}	Peak Gate Power			5	W
T_{stg}	Storage Temperature			-40 to +150	°C
T_j	Operating junction temperature			150	°C

Notes: Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15A/ μs .



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■ THERMAL RESISTANCES

PARAMETER		SYMBOL	RATINGS		UNIT
Junction to Ambient		R _{θJA}	62.5		°C/W
Junction to Case	TO-220F	R _{θJC}	3.31		°C/W
	TO-252		2.6		°C/W

■ STATIC CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
Gate trigger current	I _{GT}	T2+	G+	V _D =12V, I _T =0.1A		2.5	10	mA
		T2+	G-			4.0	10	mA
		T2-	G-			5.0	10	mA
		T2-	G+			11	25	mA
Latching Current	I _L	T2+	G+	V _D =12V, I _T =0.1A		3.2	30	mA
		T2+	G-			16	40	mA
		T2-	G-			4.0	30	mA
		T2-	G+			5.5	40	mA
Holding current	I _H	V _D =12V, I _{GT} =0.1A			4.0	30	mA	
On-State Voltage	V _T	I _T =15A			1.4	1.65	V	
Gate Trigger Voltage	V _{GT}	V _D =12V, I _T =0.1A			0.7	1.5	V	
		V _D =400V, I _T =0.1A, T _J =125°C			0.4			
Off-state leakage current	I _D	V _D =V _{DRM(max)} , T _j =125°C				0.5	mA	

■ DYNAMIC CHARACTERISTICS(T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Critical Rate Of Rise Of Off-State Voltage	dV _D /dt	V _{DM} =67%, V _{DRM(max)} , T _j =125°C Exponential waveform, Gate open circuit			50		V/μs
Gate Controlled Turn-on Time	t _{gt}	I _{TM} =16A ; V _D =V _{DRM(max)} ; I _G =0.1A dI _g /dt=5A/μs			2.0		μs



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■ TYPICAL CHARACTERISTICS (1)

Figure 1. Maximum On-State Dissipation. P_{tot} vs RMS On-state Current, $I_{T(RMS)}$, Where α =Conduction Angle.

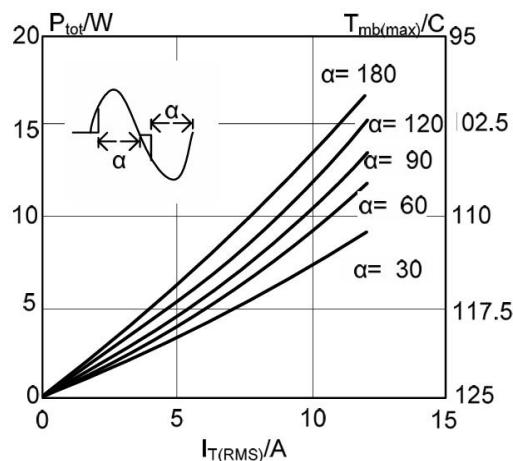


Figure 3 .Maximum Permissible Non-Repetitive Peak On-State Current I_{TSM} , vs Number of Cycles, for Sinusoidal Currents, $f=50\text{Hz}$.

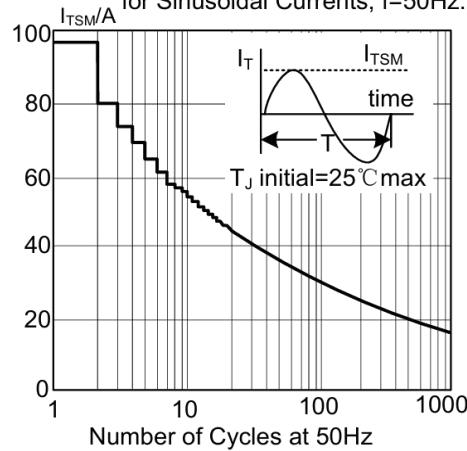


Figure 5. Maximum Permissible Repetitive RMS On-State Current $I_{T(RMS)}$, vs Surge Duration, for Sinusoidal Currents, $f=50\text{Hz}$, $T_{mb} \leq 99^\circ\text{C}$

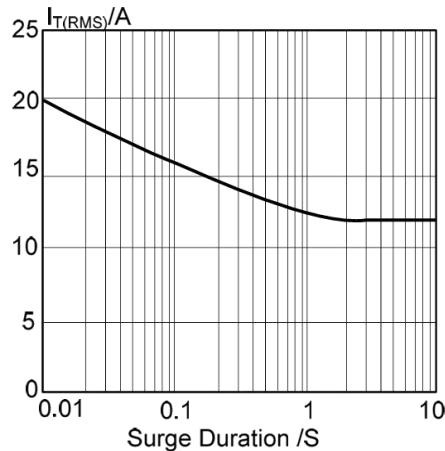


Figure 2. Maximum Permissible Non-Repetitive Peak On-State Current I_{TSM} , vs Pulse Width t_p , for Sinusoidal Currents, $t_p \leq 20\text{ms}$.

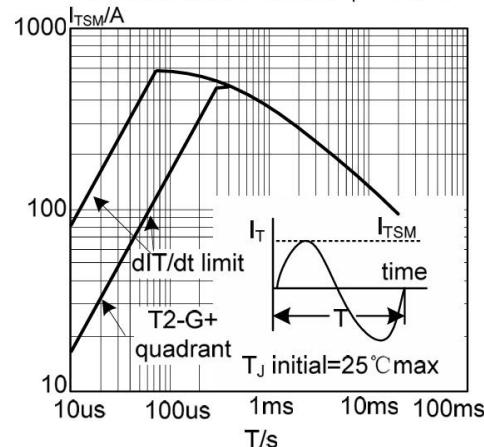


Figure 4. Maximum Permissible RMS Current $I_{T(RMS)}$ vs Mounting Base Temperature T_{mb}

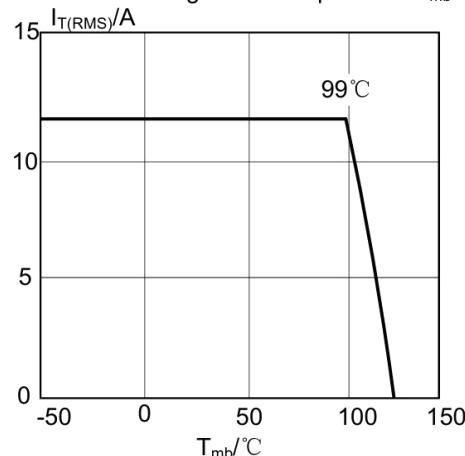
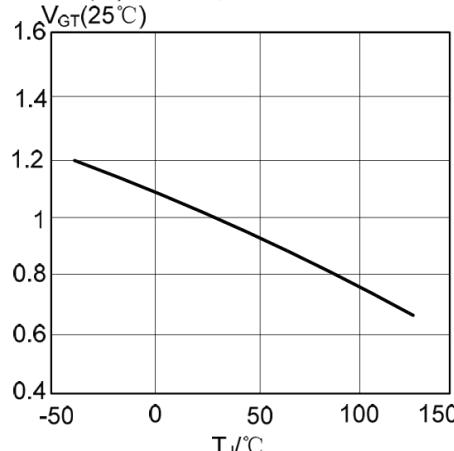


Figure 6. Normalised Gate Trigger Voltage $V_{GT}(T_J)/V_{GT}(25^\circ\text{C})$, vs Junction Temperature T_J





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■ TYPICAL CHARACTERISTICS (2)

Figure 7. Normalised Gate Trigger Current $I_{GT}(T_J)/I_{GT}(25^\circ C)$, vs Junction Temperature T_J .

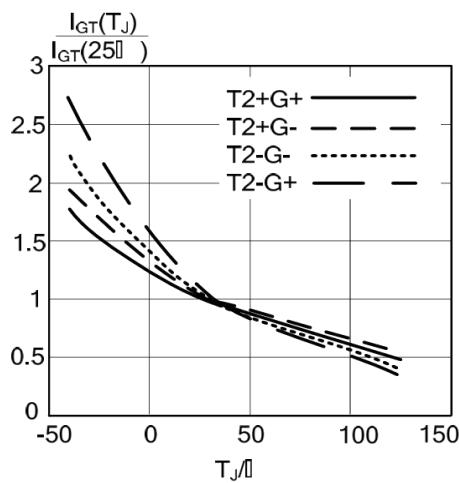


Figure 8. Normalised Latching Current $I_L(T_J)/I_L(25^\circ C)$, vs Junction Temperature T_J .

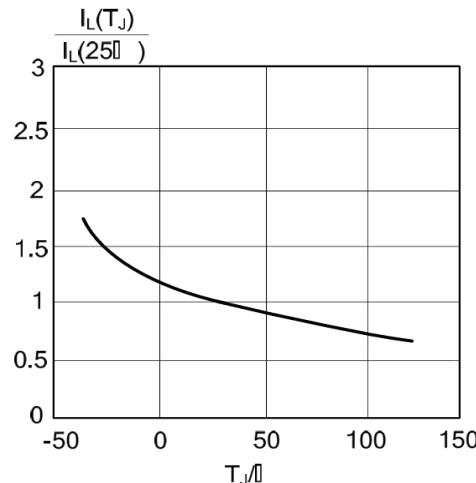


Figure 9. Normalised Holding Current $I_H(T_J)/I_H(25^\circ C)$, vs Junction Temperature T_J .

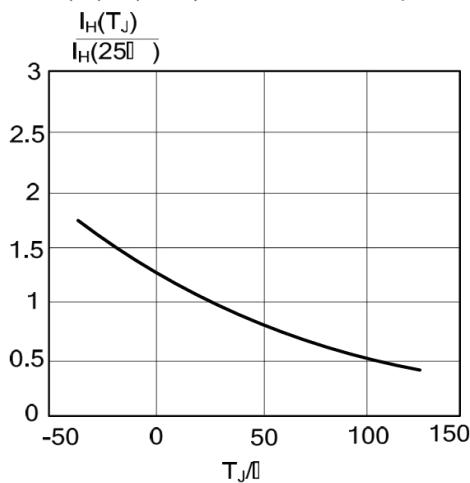


Figure 10. Typical and Maximum On-state Characteristic

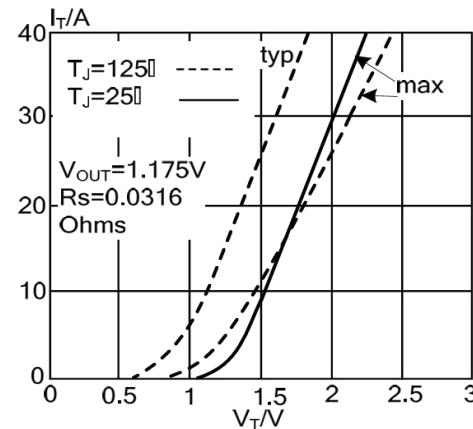


Figure 11. Transient Thermal Impedance $Z_{th,j-mb}$, vs Pulse Width t_p

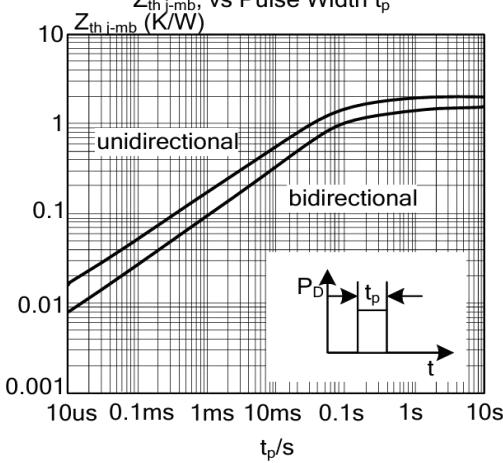
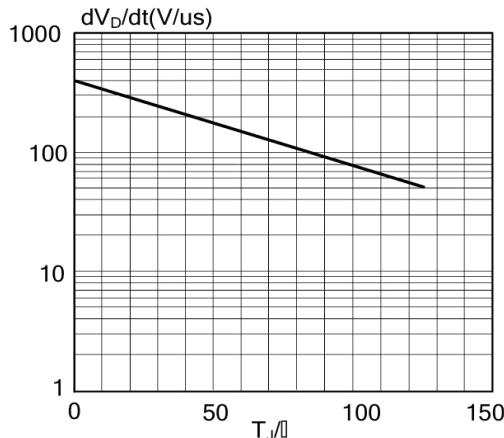


Figure 12. Typical Critical Rate of Rise of Off-State Voltage, dV_D/dt Versus Junction Temperature T_J

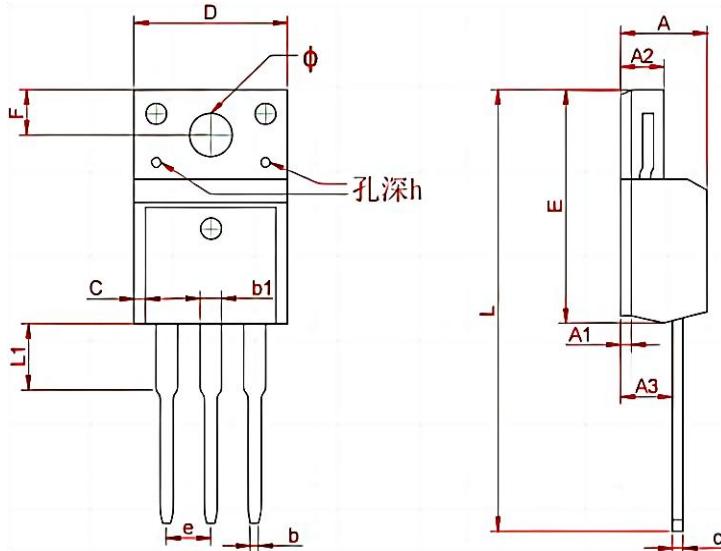




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■ TO - 220F Package Outline Dimensions

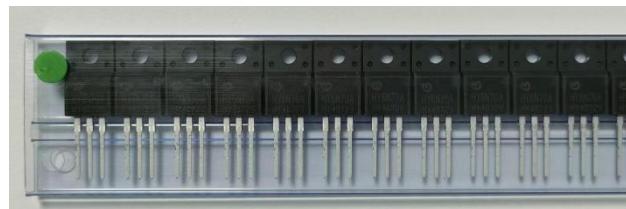


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max	Min	Max
A	4.300	4.750	0.169	0.185
A1	1.830	REF	0.072	REF
A2	2.300	2.850	0.090	0.112
A3	2.500	2.900	0.098	0.114
b	0.400	0.420	0.016	0.016
b1	1.220	1.280	0.048	0.050
C	0.690	0.720	0.027	0.028
c	0.490	0.510	0.019	0.020
D	9.960	10.200	0.392	0.400
E	15.000	15.950	0.588	0.625
e	2.574	TYP	0.101	TYP
F	3.470	REF	0.136	REF
y	3.200	REF	0.125	REF
h	0.000	0.300	0.000	0.012
L	28.780	28.900	1.128	1.133
L1	2.990	3.100	0.117	0.122

■ TO - 220F Packing Information



50PCS



20 Tube



5 Inner Box



Inner Box

Outer Box

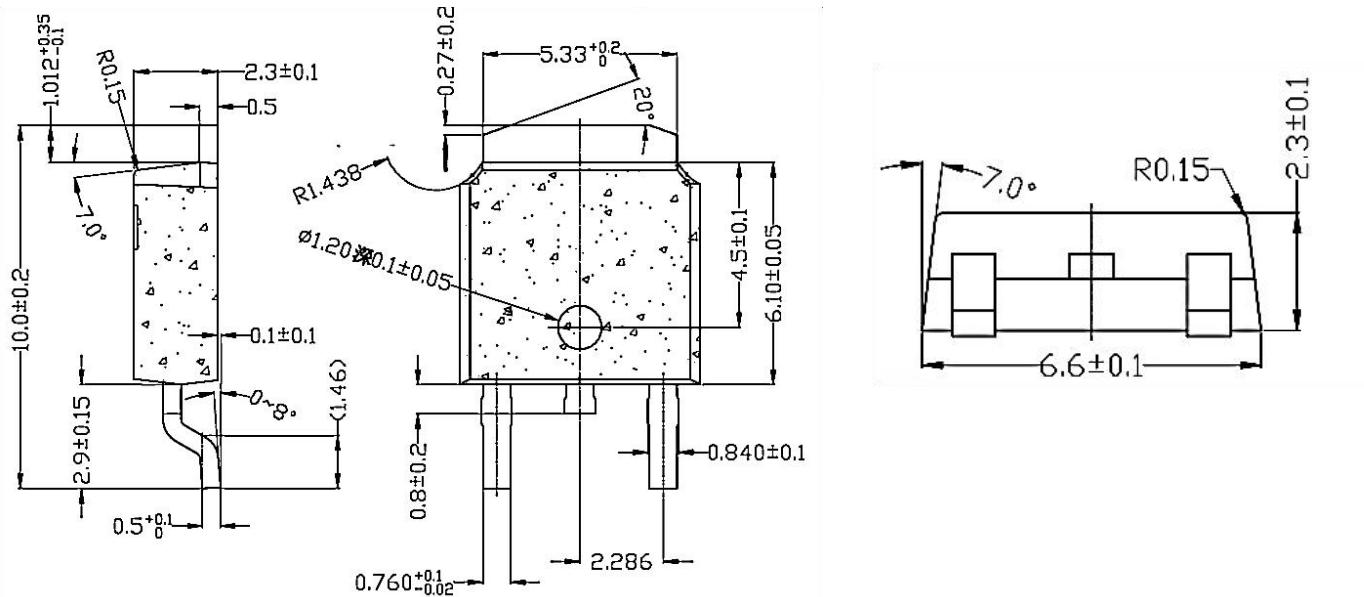
Package version	Tube dimensions LxWxH (mm)	Per Tube (pcs)	Tube per box	Inner box dimensions LxWxH (mm)	PCS/Inner box	Outer box dimensions LxWxH(mm)	PCS/Outer box
TO-220F	530*32*7	50	20	580*155*50	1000	602*277*188	5000



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■ TO - 252 Package Outline Dimensions



■ TO - 252 Packing Information



Package version	Reel dimensions $\Phi \times H$ (mm)	Per Reel (pcs)	Reels per box	Inner box dimensions L×W×H (mm)	Outer box (pcs)	Outer box dimensions L×W×H (mm)
TO-252	$\Phi 330 \times 20$	2500	2	360*340*50	25000	375*375*280